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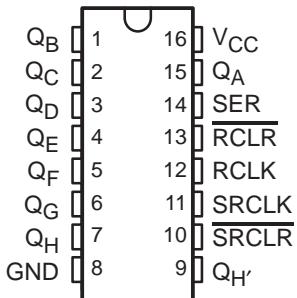
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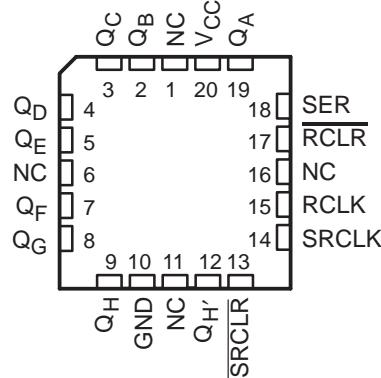
Jameco Part Number 916351

- Wide Operating Voltage Range of 2 V to 6 V
- High-Current Outputs Can Drive Up To 15 LSTTL Loads
- Low Power Consumption, 80- $\mu$ A Max  $I_{CC}$
- Typical  $t_{pd} = 15$  ns
- $\pm 6$ -mA Output Drive at 5 V
- Low Input Current of 1  $\mu$ A Max
- 8-Bit Serial-In, Parallel-Out Shift Registers With Storage
- Independent Direct Overriding Clears on Shift and Storage Registers
- Independent Clocks for Both Shift and Storage Registers

SN54HC594 . . . J OR W PACKAGE  
SN74HC594 . . . D, DW, OR N PACKAGE  
(TOP VIEW)



SN54HC594 . . . FK PACKAGE  
(TOP VIEW)



NC – No internal connection

### description/ordering information

The 'HC594 devices contain an 8-bit serial-in, parallel-out shift register that feeds an 8-bit D-type storage register. Separate clocks and direct overriding clear (RCLR, SRCLR) inputs are provided on both the shift and storage registers. A serial (Q<sub>H'</sub>) output is provided for cascading purposes.

Both the shift register (SRCLK) and storage register (RCLK) clocks are positive edge triggered. If both clocks are connected together, the shift register always is one count pulse ahead of the storage register.

The parallel (Q<sub>A</sub>–Q<sub>H</sub>) outputs have high-current capability. Q<sub>H'</sub> is a standard output.

### ORDERING INFORMATION

TA	PACKAGE†		ORDERABLE PART NUMBER	TOP-SIDE MARKING
–40°C to 85°C	PDIP – N	Tube of 25	SN74HC594N	SN74HC594N
		Tube of 40	SN74HC594D	HC594
		Reel of 2500	SN74HC594DR	
	SOIC – DW	Reel of 250	SN74HC594DT	HC594
		Tube of 40	SN74HC594DW	
	SOIC – DW	Reel of 2000	SN74HC594DWR	
–55°C to 125°C	CDIP – J	Tube of 25	SNJ54HC594J	SNJ54HC594J
	CFP – W	Tube of 150	SNJ54HC594W	SNJ54HC594W
	LCCC – FK	Tube of 55	SNJ54HC594FK	SNJ54HC594FK

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).

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**TEXAS  
INSTRUMENTS**

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**SN54HC594, SN74HC594  
8-BIT SHIFT REGISTERS  
WITH OUTPUT REGISTERS**

SCLS040F – DECEMBER 1982 – REVISED OCTOBER 2003

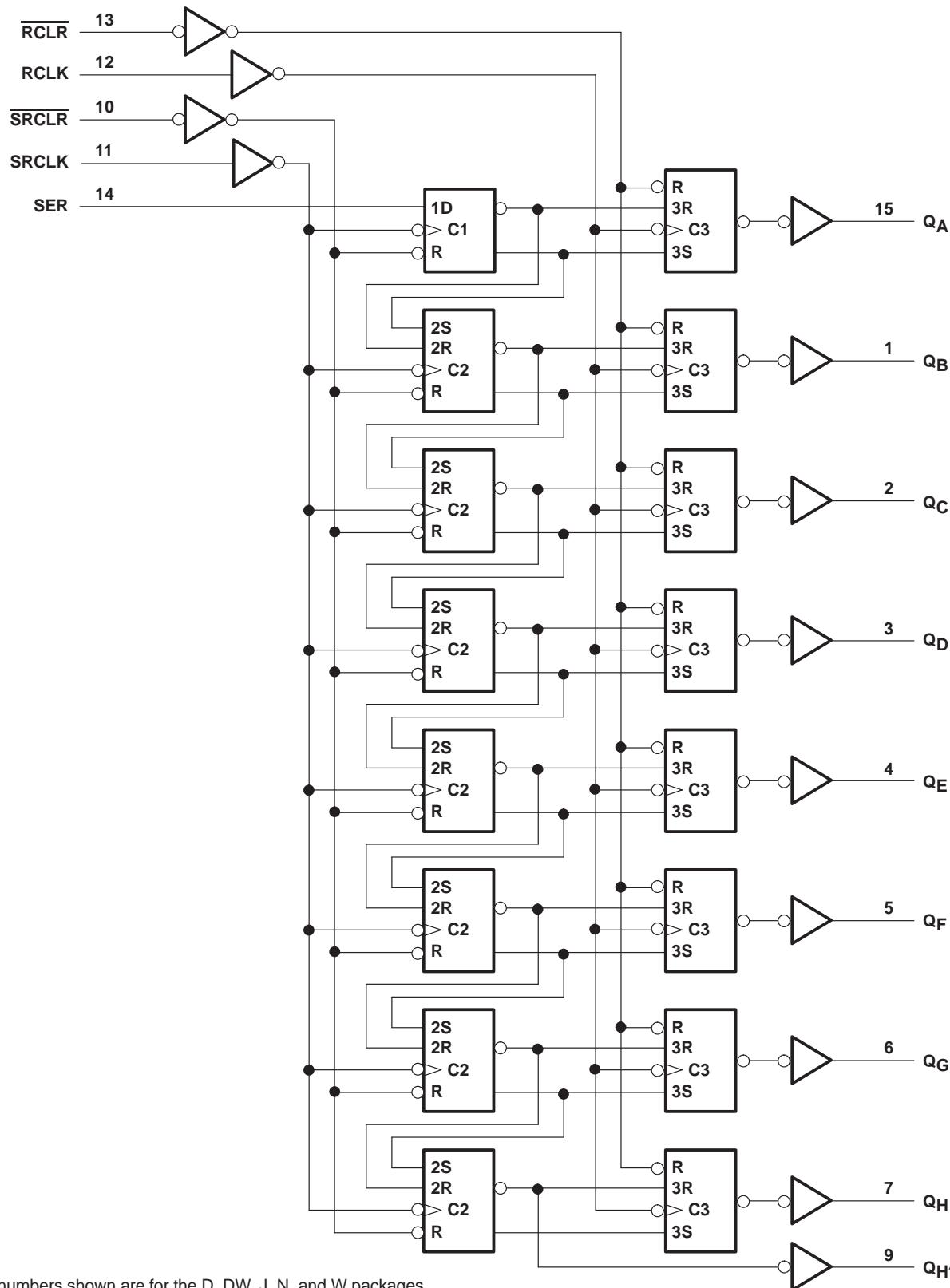
FUNCTION TABLE

INPUTS					FUNCTION
SER	SRCLK	SRCLR	RCLK	RCLR	
X	X	L	X	X	Shift register is cleared.
L	↑	H	X	X	First stage of shift register goes low. Other stages store the data of previous stage, respectively.
H	↑	H	X	X	First stage of shift register goes high. Other stages store the data of previous stage, respectively.
L	↓	H	X	X	Shift register state is not changed.
X	X	X	X	L	Storage register is cleared.
X	X	X	↑	H	Shift register data is stored in the storage register.
X	X	X	↓	H	Storage register state is not changed.



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**logic diagram (positive logic)**

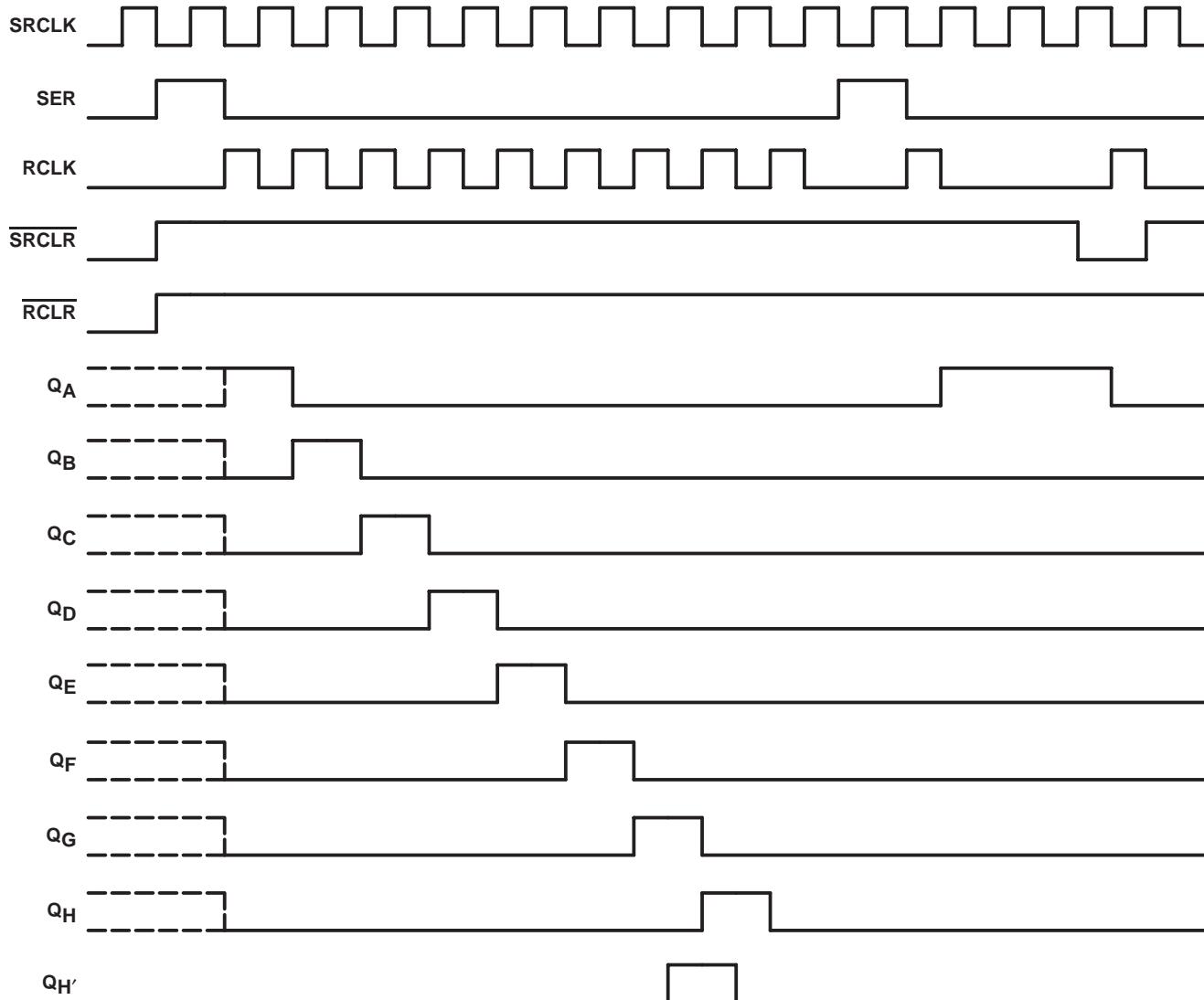


Pin numbers shown are for the D, DW, J, N, and W packages.

# **SN54HC594, SN74HC594 8-BIT SHIFT REGISTERS WITH OUTPUT REGISTERS**

SCLS040F – DECEMBER 1982 – REVISED OCTOBER 2003

## timing diagram



**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

† Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.  
2. The package thermal impedance is calculated in accordance with JEDEC 51-7.



recommended operating conditions (see Note 3)

			SN54HC594			SN74HC594			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	
V <sub>CC</sub>	Supply voltage		2	5	6	2	5	6	V
V <sub>IH</sub>	High-level input voltage	V <sub>CC</sub> = 2 V	1.5			1.5			V
		V <sub>CC</sub> = 4.5 V	3.15			3.15			
		V <sub>CC</sub> = 6 V	4.2			4.2			
V <sub>IL</sub>	Low-level input voltage	V <sub>CC</sub> = 2 V		0.5			0.5		V
		V <sub>CC</sub> = 4.5 V		1.35			1.35		
		V <sub>CC</sub> = 6 V		1.8			1.8		
V <sub>I</sub>	Input voltage		0	V <sub>CC</sub>	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
V <sub>O</sub>	Output voltage		0	V <sub>CC</sub>	0	V <sub>CC</sub>	0	V <sub>CC</sub>	V
t <sub>t</sub>	Input transition (rise and fall) time	V <sub>CC</sub> = 2 V			1000			1000	ns
		V <sub>CC</sub> = 4.5 V			500			500	
		V <sub>CC</sub> = 6 V			400			400	
T <sub>A</sub>	Operating free-air temperature		-55		125	-40		85	°C

NOTE 3: All unused inputs of the device must be held at V<sub>CC</sub> or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS	V <sub>CC</sub>	T <sub>A</sub> = 25°C			SN54HC594		SN74HC594		UNIT
			MIN	TYP	MAX	MIN	MAX	MIN	MAX	
V <sub>OH</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -20 µA	2 V	1.9	1.998	1.9		1.9		V
			4.5 V	4.4	4.499	4.4		4.4		
			6 V	5.9	5.999	5.9		5.9		
		Q <sub>H'</sub> , I <sub>OH</sub> = -4 mA	4.5 V	3.98	4.3	3.7		3.84		
				3.98	4.3	3.7		3.84		
		Q <sub>A</sub> -Q <sub>H</sub> , I <sub>OH</sub> = -6 mA	6 V	5.48	5.8	5.2		5.34		
				5.48	5.8	5.2		5.34		
		Q <sub>H'</sub> , I <sub>OH</sub> = -5.2 mA	6 V	0.17	0.26	0.4		0.33		
				0.17	0.26	0.4		0.33		
				0.15	0.26	0.4		0.33		
				0.15	0.26	0.4		0.33		
				0.15	0.26	0.4		0.33		
V <sub>OL</sub>	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OL</sub> = 20 µA	2 V	0.002	0.1	0.1		0.1		V
			4.5 V	0.001	0.1	0.1		0.1		
			6 V	0.001	0.1	0.1		0.1		
		Q <sub>H'</sub> , I <sub>OL</sub> = 4 mA	4.5 V	0.17	0.26	0.4		0.33		
				0.17	0.26	0.4		0.33		
		Q <sub>A</sub> -Q <sub>H</sub> , I <sub>OL</sub> = 6 mA	6 V	0.15	0.26	0.4		0.33		
				0.15	0.26	0.4		0.33		
I <sub>I</sub>	V <sub>I</sub> = V <sub>CC</sub> or 0	6 V		±0.1	±100	±1000		±1000		nA
I <sub>OZ</sub>	V <sub>O</sub> = V <sub>CC</sub> or 0	6 V		±0.01	±0.5	±10		±5		µA
I <sub>CC</sub>	V <sub>I</sub> = V <sub>CC</sub> or 0, I <sub>O</sub> = 0	6 V			8	160		80		µA
C <sub>i</sub>		2 V to 6 V		3	10	10		10		pF

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**SN54HC594, SN74HC594  
8-BIT SHIFT REGISTERS  
WITH OUTPUT REGISTERS**

SCLS040F – DECEMBER 1982 – REVISED OCTOBER 2003

**timing requirements over recommended operating free-air temperature range (unless otherwise noted)**

		V <sub>CC</sub>	T <sub>A</sub> = 25°C		SN54HC594		SN74HC594		UNIT	
			MIN	MAX	MIN	MAX	MIN	MAX		
f <sub>clock</sub>	Clock frequency	2 V	5		3.3		4		MHz	
		4.5 V	25		17		20			
		6 V	29		20		24			
t <sub>w</sub>	Pulse duration	SRCLK or RCLK high or low	2 V	100	150		125		ns	
			4.5 V	20	30		25			
			6 V	17	25		21			
		SRCLR or RCLR low	2 V	100	150		125			
			4.5 V	20	30		25			
			6 V	17	25		21			
t <sub>su</sub>	Setup time	SER before SRCLK↑	2 V	90	135		110		ns	
			4.5 V	18	27		22			
			6 V	15	23		19			
		SRCLK↑ before RCLK↑†	2 V	90	135		110			
			4.5 V	18	27		22			
			6 V	15	23		19			
	SRCLR low before RCLK↑	2 V	50		75		63			
			4.5 V	10	15		13			
		6 V	9		13		11			
			2 V	20	20		20			
	SRCLR high (inactive) before SRCLK↑	4.5 V	10		10		10			
			6 V	10	10		10			
		2 V	5		5		5			
			4.5 V	5	5		5			
		6 V	5		5		5			
t <sub>h</sub>	Hold time, SER after SRCLK↑		2 V	5	5		5		ns	
			4.5 V	5	5		5			
			6 V	5	5		5			

† This setup time ensures that the output register receives stable data from the shift-register outputs. The clocks may be tied together, in which case the output register is one clock pulse behind the shift register.

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switching characteristics over recommended operating free-air temperature range,  $C_L = 50 \text{ pF}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HC594	SN74HC594	UNIT
				MIN	TYP	MAX	MIN	MAX	
$f_{max}$			2 V	5	8	3.3	4		MHz
			4.5 V	25	35	17	20		
			6 V	29	40	20	24		
$t_{pd}$	SRCLK	$Q_H'$	2 V	50	150	225	185		ns
			4.5 V	20	30	45	37		
			6 V	15	25	38	31		
	RCLK	$Q_A-Q_H$	2 V	50	150	225	185		
			4.5 V	20	30	45	37		
			6 V	15	25	38	31		
$t_{PHL}$	$\overline{SRCLR}$	$Q_H'$	2 V	50	150	225	185		ns
			4.5 V	20	30	45	37		
			6 V	15	25	38	31		
	$\overline{RCLR}$	$Q_A-Q_H$	2 V	50	125	185	155		
			4.5 V	20	25	37	31		
			6 V	15	21	31	26		
$t_t$		$Q_H'$	2 V	38	75	110	95		ns
			4.5 V	8	15	22	19		
			6 V	6	13	19	16		
		$Q_A-Q_H$	2 V	38	60	90	75		
			4.5 V	8	12	18	15		
			6 V	6	10	15	13		

switching characteristics over recommended operating free-air temperature range,  $C_L = 150 \text{ pF}$  (unless otherwise noted) (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	$V_{CC}$	$T_A = 25^\circ\text{C}$			SN54HC594	SN74HC594	UNIT
				MIN	TYP	MAX	MIN	MAX	
$t_{pd}$	RCLK	$Q_A-Q_H$	2 V	90	200	300	250		ns
			4.5 V	23	40	60	50		
			6 V	19	34	51	43		
$t_{PHL}$	$\overline{RCLR}$	$Q_A-Q_H$	2 V	90	200	300	250		ns
			4.5 V	23	40	60	50		
			6 V	19	34	51	43		
$t_t$		$Q_A-Q_H$	2 V	45	210	315	265		ns
			4.5 V	17	42	63	53		
			6 V	13	36	53	45		

operating characteristics,  $T_A = 25^\circ\text{C}$

PARAMETER			TEST CONDITIONS	TYP	UNIT
$C_{pd}$	Power dissipation capacitance		No load	395	pF

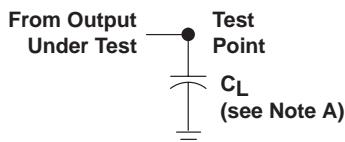
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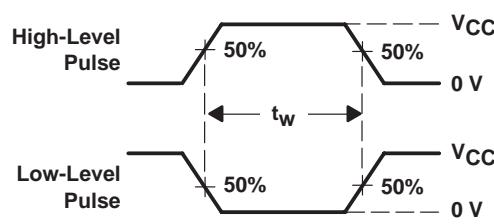
# SN54HC594, SN74HC594 8-BIT SHIFT REGISTERS WITH OUTPUT REGISTERS

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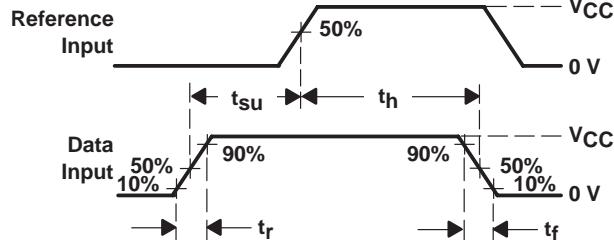
## PARAMETER MEASUREMENT INFORMATION



LOAD CIRCUIT

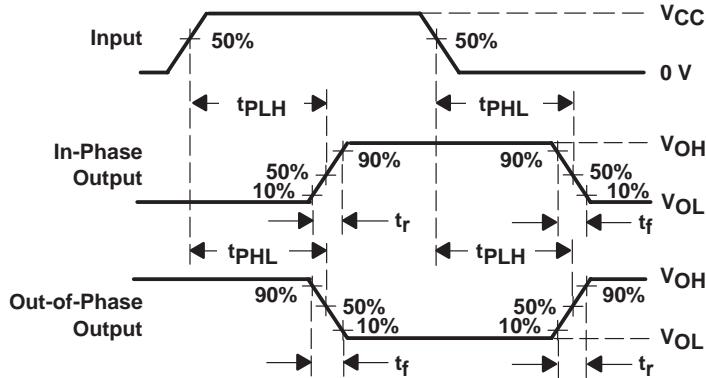


VOLTAGE WAVEFORMS  
PULSE DURATIONS



VOLTAGE WAVEFORMS

SETUP AND HOLD AND INPUT RISE AND FALL TIMES



VOLTAGE WAVEFORMS

PROPAGATION DELAY AND OUTPUT TRANSITION TIMES

NOTES:

- $C_L$  includes probe and test-fixture capacitance.
- Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq 1$  MHz,  $Z_O = 50\ \Omega$ ,  $t_r = 6\text{ ns}$ ,  $t_f = 6\text{ ns}$ .
- For clock inputs,  $f_{max}$  is measured when the input duty cycle is 50%.
- The outputs are measured one at a time with one input transition per measurement.
- $t_{PLH}$  and  $t_{PHL}$  are the same as  $t_{pd}$ .
- $t_f$  and  $t_r$  are the same as  $t_t$ .

Figure 1. Load Circuit and Voltage Waveforms

**PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74HC594D	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DE4	ACTIVE	SOIC	D	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DR	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DRE4	ACTIVE	SOIC	D	16	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DT	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DTE4	ACTIVE	SOIC	D	16	250	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DW	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DWE4	ACTIVE	SOIC	DW	16	40	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DWR	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594DWRE4	ACTIVE	SOIC	DW	16	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74HC594N	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74HC594NE4	ACTIVE	PDIP	N	16	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBsolete:** TI has discontinued the production of the device.

<sup>(2)</sup> Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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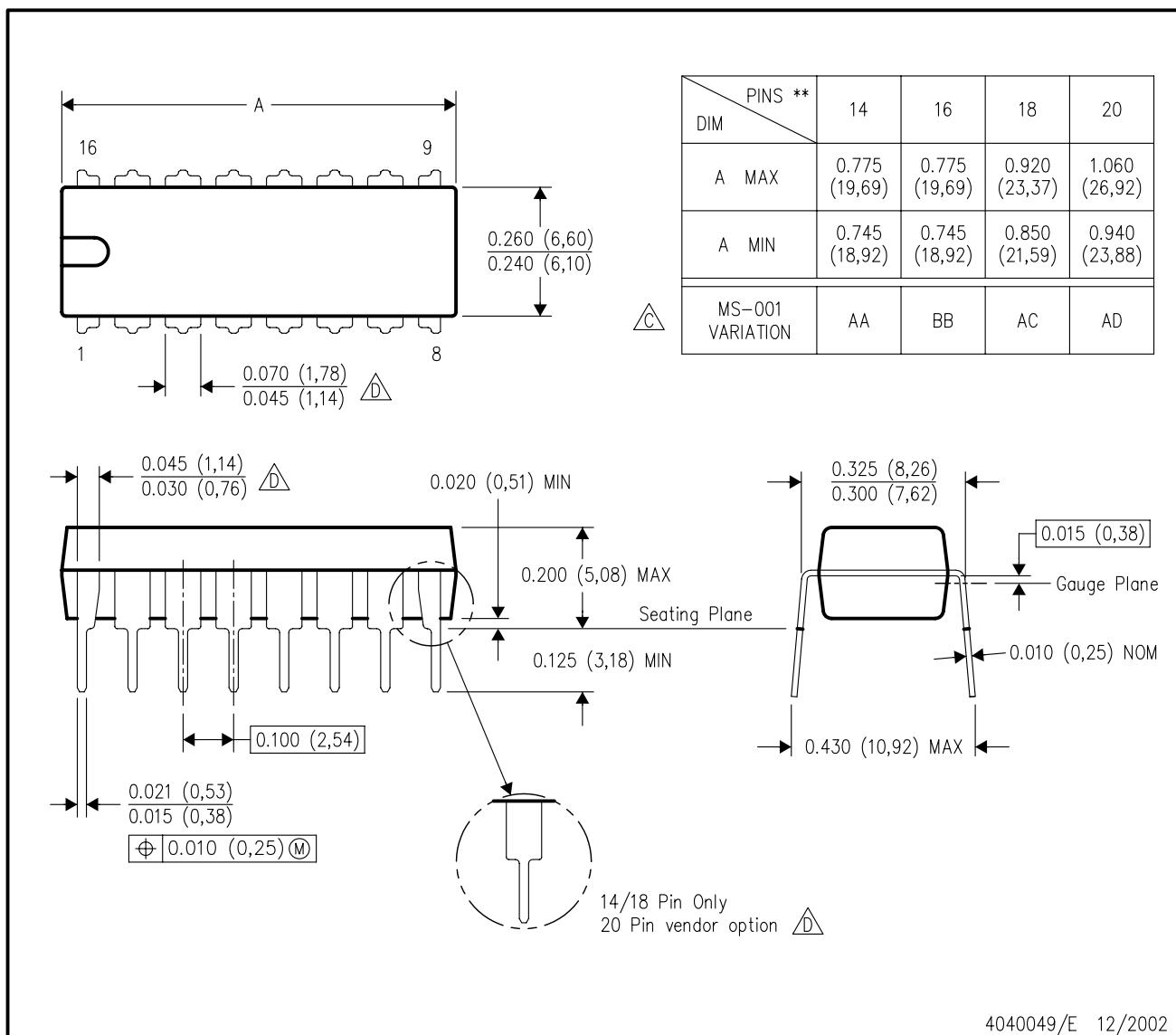
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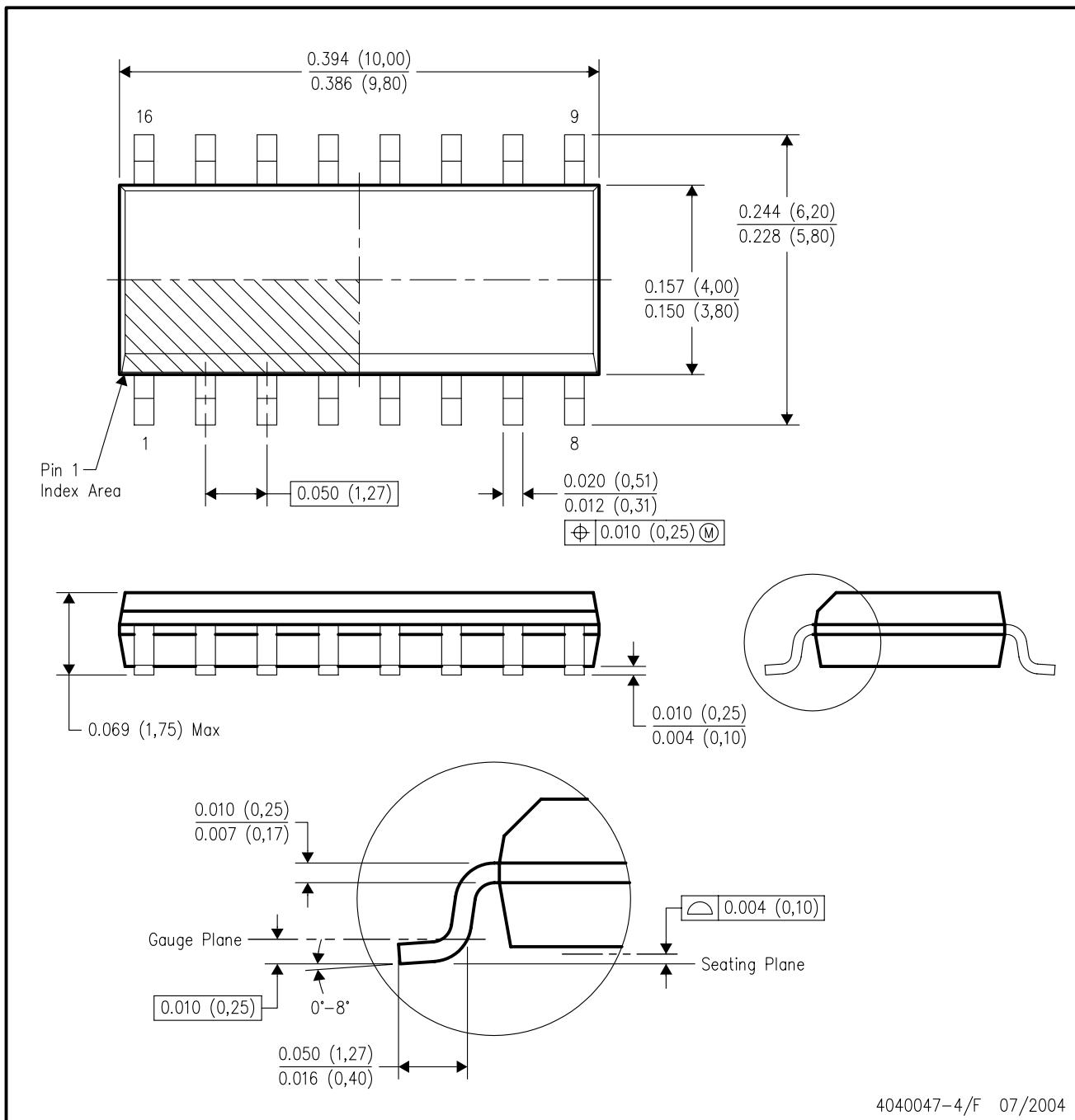
16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



## D (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



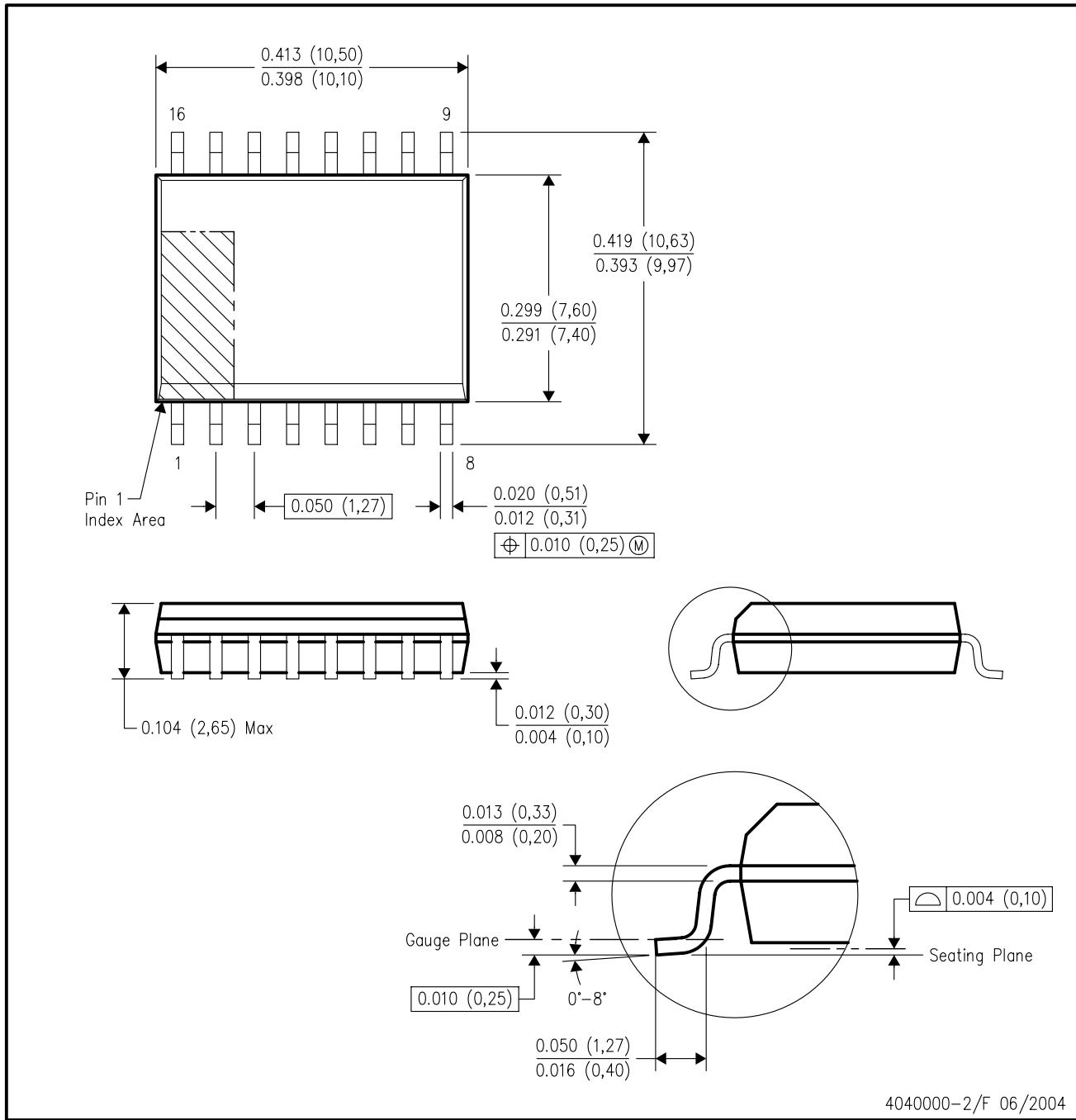
4040047-4/F 07/2004

NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-012 variation AC.

## DW (R-PDSO-G16)

## PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- Falls within JEDEC MS-013 variation AA.

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